Specification for Approval

Date: 2017/05/28

Customer : 深圳台慶

TAI-TECH P/N: AHP201610TF-SERIES

CUSTOMER P/N:

DESCRIPTION:

QUANTITY: pcs

REMARK:		
Customer Approval Feedback		

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Power Inductor

AHP201610TF-SERIES

ECN HISTORY LIST

REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN
1.0	15/02/16	新 發 行	楊祥忠	詹偉特	林宜蘊
備 註					

Power Inductor

AHP201610TF-SERIES

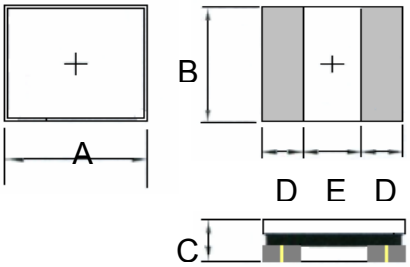
1. Features

1. This specification applies Low Profile Power Inductor.
2. 100% Lead(Pb) & Halogen-Free and RoHS compliant.

Halogen-free

Pb-free

2. Dimension



Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)
AHP201610TF	2.0 -0.1/+0.2	1.6 -0.1/+0.2	1.0Max	0.60 ref.	0.80 ref.

Units: mm

3. Part Numbering

AHP	201610	TF	-	R24	M
A	B	C		D	E

A: Series
B: Dimension
C: Lead Free — Material
D: Inductance — R24=0.24uH
E: Inductance Tolerance — M=±20%

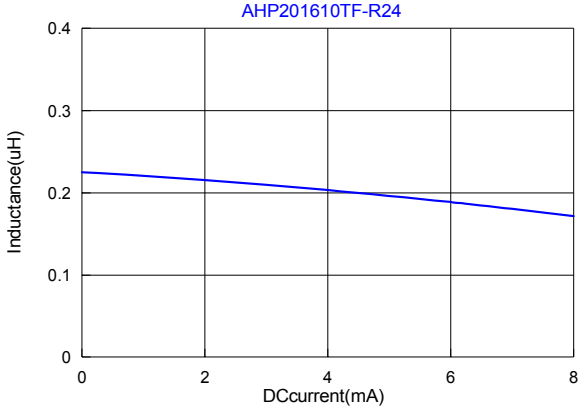
4. Specification

TAI-TECH Part Number	Inductance (uH)	Tolerance (%)	DCR (Ω) typ.	DCR (Ω) Max.	I sat (A) typ.	I sat (A) Max.	I rms (A) typ	I rms (A) MAX
AHP201610TF-R24M-1	0.24	±20	0.026	0.032	6.80	5.90	4.20	3.70
AHP201610TF-R33M-1	0.33	±20	0.032	0.038	6.00	5.50	4.0	3.60
AHP201610TF-R47M-1	0.47	±20	0.035	0.044	5.20	4.30	3.60	3.20
AHP201610TF-R68M-1	0.68	±20	0.056	0.064	4.20	3.60	2.90	2.60
AHP201610TF-1R0M-1	1.00	±20	0.070	0.085	3.10	2.70	2.45	2.20
AHP201610TF-1R5M-1	1.50	±20	0.105	0.125	2.90	2.60	2.30	2.00
AHP201610TF-2R2M-1	2.2	±20	0.140	0.170	2.20	1.90	1.85	1.65

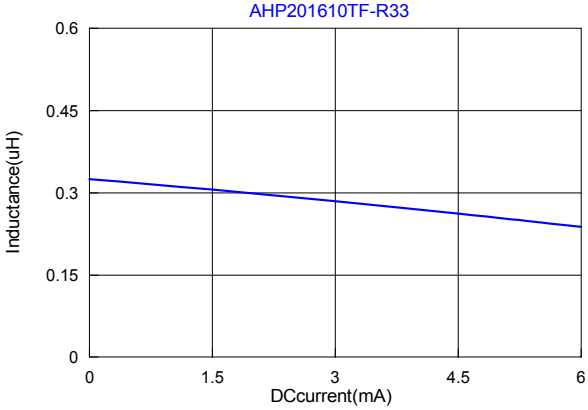
Note:

1. Test frequency : L : 1MHz /1.0V
2. Isat：Based on inductance change （△L/L0：≦-30%）@ ambient temp. 25℃
3. Irms：Based on temperature rise （△T：40℃.）Max

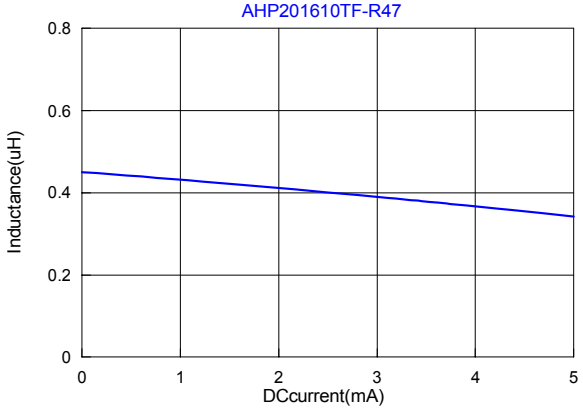
AHP201610TF-R24



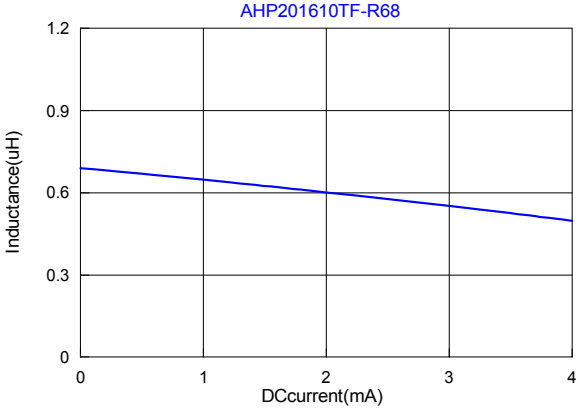
AHP201610TF-R33



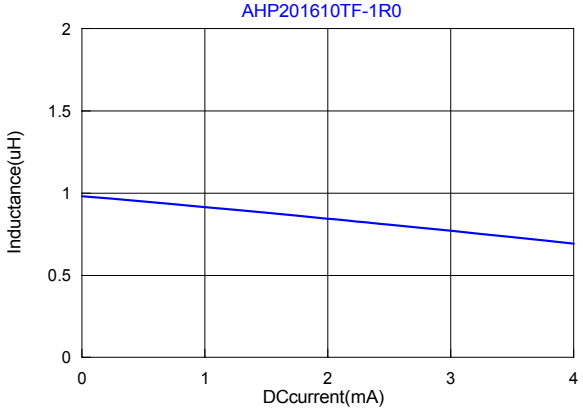
AHP201610TF-R47



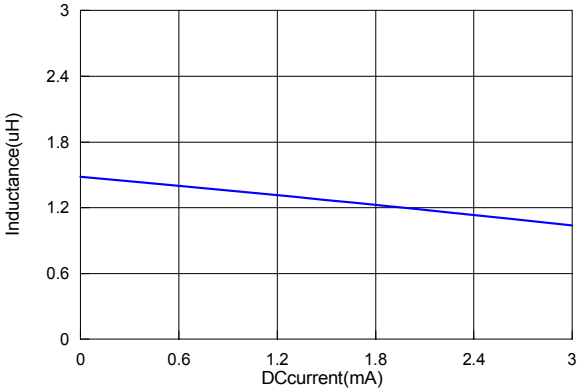
AHP201610TF-R68



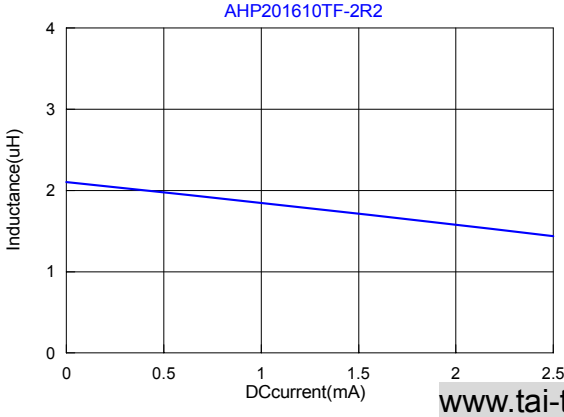
AHP201610TF-1R0



AHP201610TF-1R5

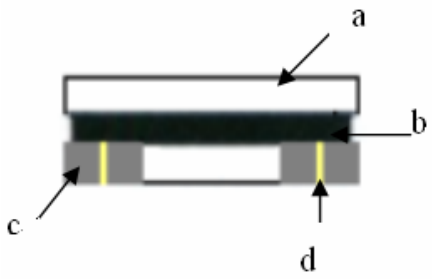


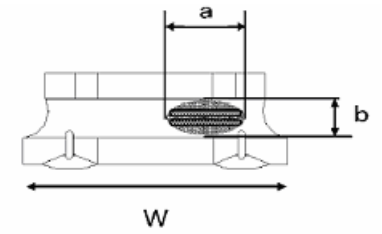
AHP201610TF-2R2



5. Material List

No.	Description	Specification
a.	Core	Metal Magnetic Core
b.	Coating	Epoxy with Magnetic powder
c	Termination	Tin (Pb Free)
d	Wire	Enameled Copper Wire





Appearance of exposed wire tolerance limit:

1. Width direction（dimension a）: Acceptable when a≦w/2
   Nonconforming when a＞w/2
2. Length direction（dimension b）: Dimension b is not specified.
3. The total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, and is acceptable.

6. Reliability and Test Condition

Item	Performance	Test Condition
Operating Temperature	-40~+125℃	
Storage Temperature (on board)		
Electrical Performance Test		
Inductance L	Refer to standard electrical characteristic list	Agilent-4291, Agilent-4287
DC Resistance		Agilent-4338
Rated Current	Base on temp. rise & △L/L0A≦30%.	Saturation DC Current (Isat) will cause L0 to drop approximately △L(%).
Temperature Rise Test	ΔT 40℃Max	Heat Rated Current (Irms) will cause the coil temperature rise approximately △T(℃) without core loss. 1.Applied the allowed DC current. 2.Temperature measured by digital surface thermometer
Mechanical Performance Test		
Solder Heat Resistance	Appearance：No damage. Inductance：within±10% of initial value RDC：within ±15% of initial value and shall not exceed the specification value	<table><tr><th>Temperature (°C)</th><th>Time (s)</th><th>Temperature ramp/immersion and emersion rate</th><th>Number of heat cycles</th></tr><tr><td>260 ±5 (solder temp)</td><td>10 ±1</td><td>25mm/s±6 mm/s</td><td>1</td></tr></table> Depth: completely cover the termination

Item	Performance	Test Condition
Solderability Test	More than 95% of terminal electrode should be covered with solder.	Preheat: 150℃,60sec.◦ Solder: Sn99.5%-Cu0. 5%◦ Temperature: 245±5℃◦ Flux for lead free: Rosin. 9.5%◦ Dip time: 4±1sec◦ Depth: completely cover the termination
Reliability Test		
Life Test	Appearance：No damage. Inductance：within±10% of initial value RDC：within ±15% of initial value and shall not exceed the specification value	Preconditioning:Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Temperature： 85±2℃ Applied current：rated current Duration：1000±12hrs Measured at room temperature after placing for 24±2 hrs
Thermal shock		Preconditioning:Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Step1：-40±2℃ 30±5min Step2：25±2℃ ≦0.5min Step3：105±2℃ 30±5min Number of cycles： 500 Measured at room temperature after placing for 24±2 hrs
Humidity Resistance Test		Preconditioning:Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity：85±2% R.H, Temperature：85℃±2℃ Duration：1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs
Vibration Test		Preconditioning:Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Oscillation Frequency: 10～2K～10Hz for 20 minutes Equipment： Vibration checker Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations)◦

7. Soldering and Mounting

7-1. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

7-1.1 Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

7-1.2 Soldering Iron(Figure 2):

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

- Preheat circuit and products to 150℃
- Never contact the ceramic with the iron tip
- Use a 20 watt soldering iron with tip diameter of 1.0mm
- 355℃ tip temperature (max)
- 1.0mm tip diameter (max)
- Limit soldering time to 4~5 sec.

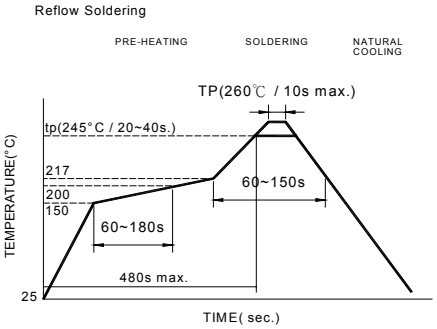
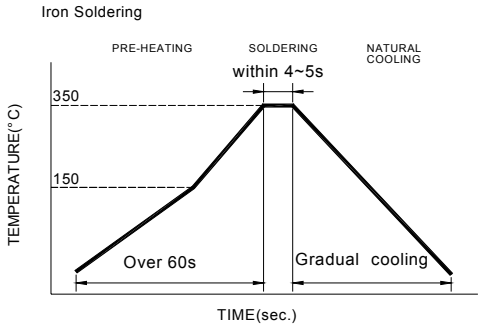


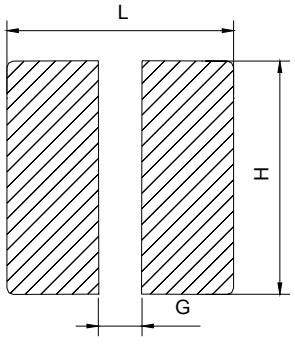
Fig.1



Iron Soldering times: 1 times max.

Fig.2

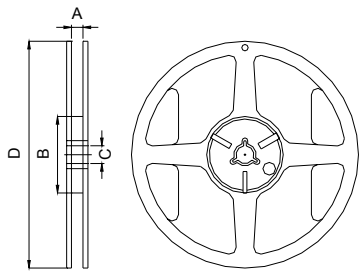
7-2. Recommended PC Board Pattern



L(mm)	G(mm)	H(mm)
2.3	0.7	1.7

8. Packaging Information

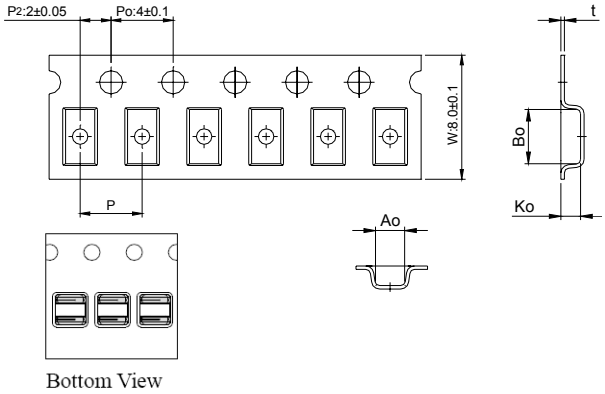
8-1. Reel Dimension



7"x8mm

Type	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	8.4±1.0	50 min.	13±0.8	178±2

8-2. Tape Dimension / 8mm



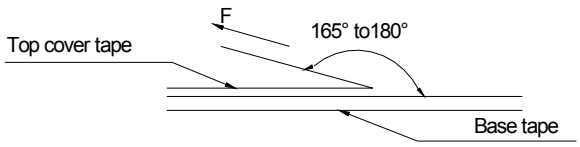
Bottom View

Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)
AHP	201610	2.5±0.1	2.0±0.1	1.40±0.1	4.0±0.1	0.23±0.05

8-3. Packaging Quantity

Chip size	201610
Chip / Reel	2000

8-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp. (℃)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min
5~35	45~85	860~1060	300

Application Notice

- Storage Conditions(component level)
  To maintain the solderability of terminal electrodes:
  1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
  2. Temperature and humidity conditions: Less than 40℃ and 60% RH.
  3. Recommended products should be used within 12 months form the time of delivery.
  4. The packaging material should be kept where no chlorine or sulfur exists in the air.

- Transportation
  1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
  2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
  3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

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